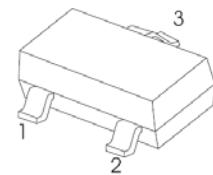


Fast Switching Speed Diode

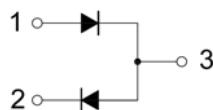
FEATURES

- For surface mount applications
- Fast reverse recovery time
- Ideal for automated placement
- AEC-Q101 qualified (Automotive grade with suffix "Q.")
- Exsemi technology

SOT-23



MARKING: A7



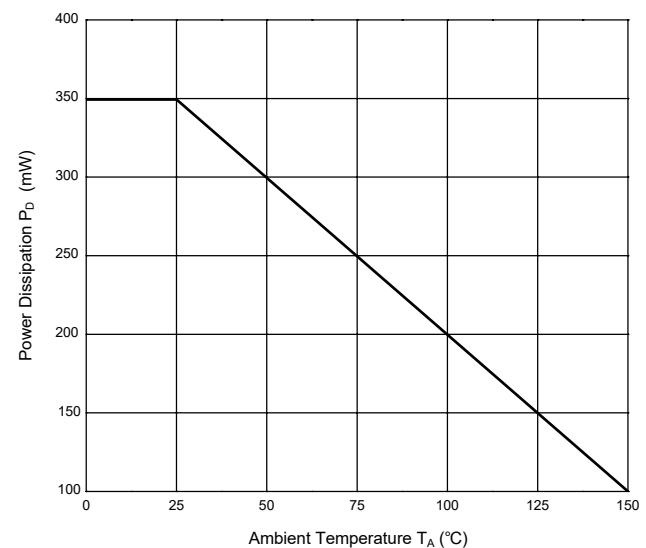
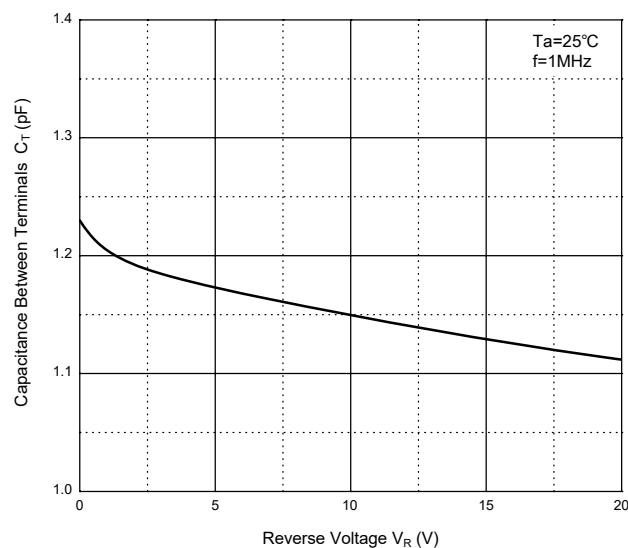
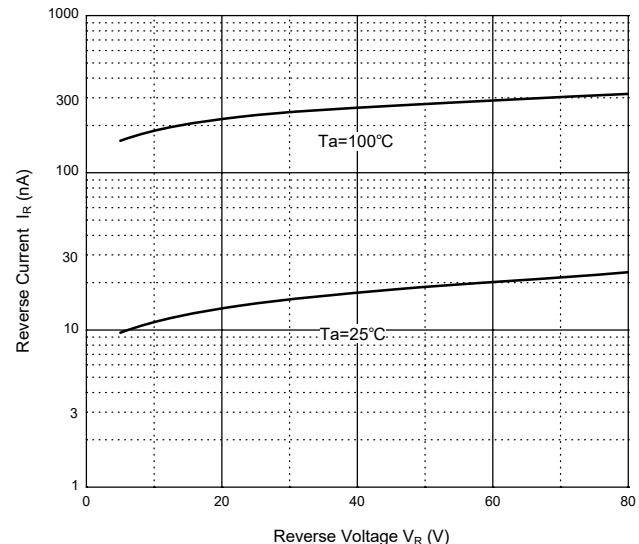
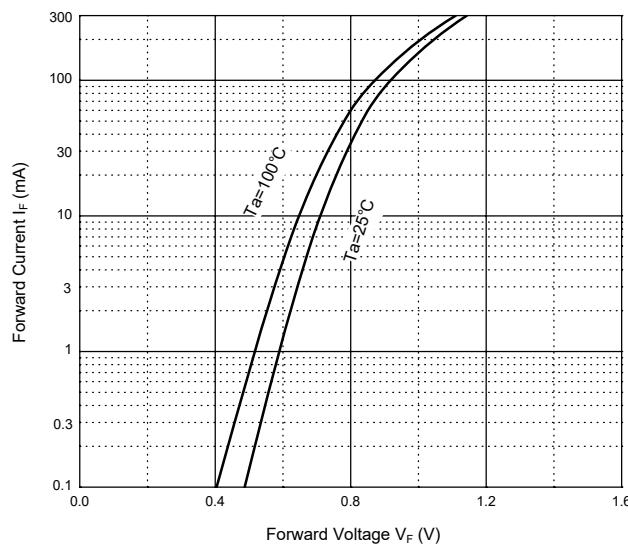
Maximum Ratings @Ta=25°C

Parameter	Symbol	Limit	Unit
Reverse Voltage	V _R	100	V
Forward Current	I _F	200	mA
Non-Repetitive Peak Forward Surge Current at t=1 s at t=1 ms at t=1 μs	I _{FSM}	0.5 1 4.5	A
Power Dissipation	P _D	350	mW
Thermal Resistance Junction to Ambient	R _{θJA}	556	°C/W
Junction Temperature	T _J	150	°C
Storage Temperature range	T _{STG}	-65~+150	°C

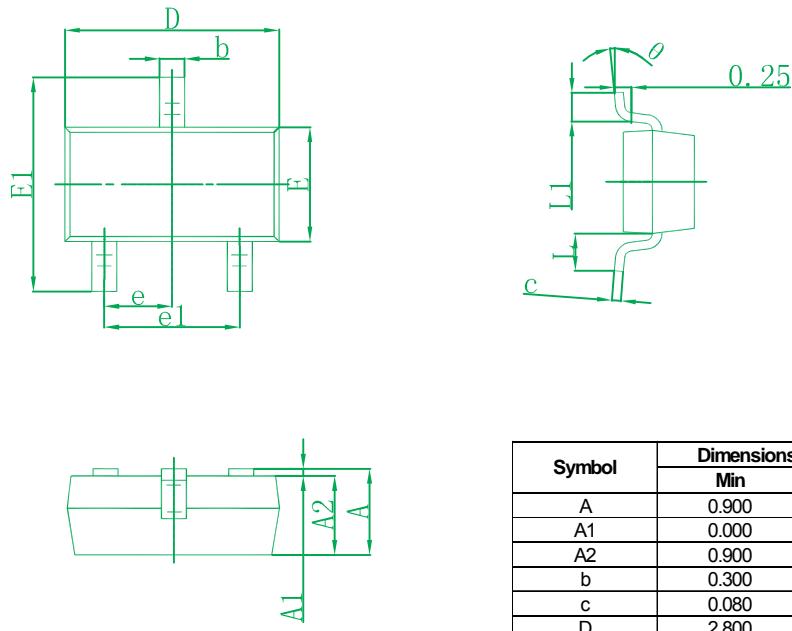
Electrical Characteristics @Ta=25°C

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Reverse breakdown voltage	V _R	100			V	I _R =100μA
Forward voltage	V _{F1}			0.715	V	I _F =1mA
	V _{F2}			0.855	V	I _F =10mA
	V _{F3}			1	V	I _F =50mA
	V _{F4}			1.25	V	I _F =150mA
Revers current	I _R			0.03		V _R =25V
	I _R			1		V _R =100V
	I _R			30		V _R =25V, T _J =150°C
	I _R			50	μA	V _R =100V, T _J =150°C
Capacitance between terminals	C _T			1.5	pF	V _R =0,f=1MHz
Reverse recovery time	t _{rr}			6	ns	I _F = I _R = 10mA, I _{rr} = 0.1 × I _R , R _L = 100Ω

Typical Characteristics

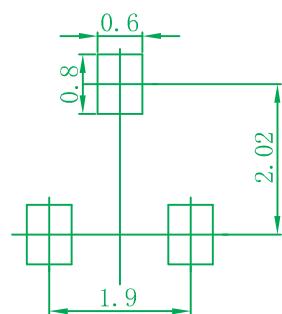


SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.150	0.035	0.045
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.050	0.110	0.120
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.360 REF		0.014 REF	
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

Ordering information

Device	Package	Shipping
BAV99-H	SOT-23	3000/Tape&Reel(7inches)